

PRODUCT/PROCESS CHANGE NOTIFICATION

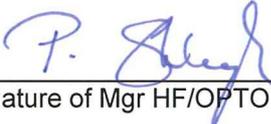
TO: ME-UK: AR
ME-Italy: PA, BE
ME-France: BA
ME-CE: MK
CC: NA, AB, FU, MG, BK, EG, BU, ST, TA, IL,
DJ, DC, SR, JL, SB, HE

DATE: 07. July 2009
FROM: MEU Mktg / Eng
Dr. P. Stelmaszyk
DEPT.: SEMI

PCN number : PCN-H-03-09

Herewith we want to inform you about the following:

- a) Product change:
Process change:
- b) Old Mitsubishi type number: RD05MMP1-xx, RD09MUP2-xx, RD12MVP1-xx
(power mini mold transistors)
- c) New Mitsubishi type number: No change
- d) Expected last order and shipment dates for unchanged devices to be supplied: Not applicable
- e) Expected first shipment date of changed devices: from Oct/M. 2009 production
- f) Manufacturing location and product line affected: Shimane Masuda Electronics
- g) Description of the proposed change: Change of production facility from Shimane Masuda Electronics to MEC Semicon. Location of production equipment and operators will be changed.
- h) Comparison table of change attached: Yes No
- i) Reliability and/or engineering test data are: attached:
available on request:
- j) Customer spec. / part number: All included


(Signature of Mgr HF/OPTO Marketing/ Engineering)

Note: Please comment until 03/08/2009. Otherwise we regard the PCN as accepted.